

**FORM TO BE FILLED BY IO WHILE CONVENING PRE-BID MEETING OF TSC.**

**File No.: 14-VII/BG(3059-GTE)25PB/T-181**

**Date: 17-03-2026**

**Pre-bid Meeting (To be typed clearly by the I/O)**

Name of Indentor: **Dr. Bhasker Gahtori**

Indent No.: **PR4031692025**

Item Description: **Thermal Conductivity Instrument**

No. of Vendors Participated: **Two** (M/S NETZSCH Technologies India Pvt. Ltd and M/S Linseis Thermal Analysis India)

(1) A pre-bid meeting of TSC was held on **17-03-2026**

(2) Following queries were raised by participating Bidders: **NIL**

<b>Name of the Firm</b>	<b>Queries Raised</b>	<b>Remarks, if any</b>
<b>NA</b>	<b>NA</b>	

Final recommended specifications are as attached at Annexure 1 and signed by I/O:

Corrigendum to Tender may be issued/ may not be issued.

Recommended Revised Date of Tender submission (if any) is \_\_\_\_\_

The specifications are generic and broad based.

Submitted to TSC for necessary approvals.

**FORM TO BE USED BY TSC FOR FINALISING PRE-BID MINUTES**

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**Date: 17-03-2026**

**TSC Minutes**

Based on the Pre-bid meeting and recommendation of I/O, following changes have been made in the specifications: NIL

<b>Original Specifications</b>	<b>Final Specifications</b>
As Tendered	No Changes

The file is forwarded to Purchase Section for uploading the final specifications and TSC minutes on the website and CPPP Portal.

Declaration: We hereby declare that we have no conflict of interest with any of the bidder in this tender